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A
PATENT

Case Docket No. ADVA225.001AUS

Date: February 23, 2002

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ASSISTANT COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231

ATTENTION: APPLICATION BRANCH

Sir:

Transmitted herewith for filing is the patent application of

Inventor(s): **Masahiro Ishida et al.**

For: **PROBABILITY ESTIMATING APPARATUS AND METHOD FOR PEAK-TO-PEAK CLOCK SKEWS**

Enclosed are:

(X) 23 sheet(s) of drawings, 53 pages of specification, claims and abstract.
(X) **UNSIGNED** declaration and power of attorney.
(X) Return prepaid postcard.

CLAIMS AS FILED

FOR	NUMBER FILED	NUMBER EXTRA	RATE	FEE
Basic Fee			\$740	\$740
Total Claims	33 - 20 =	13 x	\$18	\$234
Independent Claims	2 - 3 =	0 x	\$84	\$0
If application contains any multiple dependent claims(s), then add			\$280	\$0
TOTAL FILING FEE				\$974

(X) A check of \$974.00 for filing fee.

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February 23, 2002

Assistant Commissioner for Patents
Washington, D.C. 20231

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Attorney Docket No. : ADVA225.001AUS
Applicant(s) : Masahiro Ishida et al.
For : Probability Estimating Apparatus and Method
for Peak-to-Peak Clock Skews
Attorney : Yasuo Muramatsu
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Date of Deposit : February 23, 2002

I hereby certify that the accompanying

Transmittal; a patent application in 53 pages of specification and 23 sheets of drawings; a check of \$974 for filing fee; Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.


Yasuo Muramatsu